

MOS FIELD EFFECT TRANSISTOR μ PA1706

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

This product is N-Channel MOS Field Effect Transistor designed for DC/DC converters and power management applications of notebook computers.

FEATURES

• Super Low on-resistance

$$\begin{split} R_{DS(on)1} = 5.8 & m\Omega \text{ (TYP.) (VGs} = 10 \text{ V, ID} = 7.0 \text{ A)} \\ R_{DS(on)2} = 7.0 & m\Omega \text{ (TYP.) (VGs} = 4.5 \text{ V, ID} = 7.0 \text{ A)} \end{split}$$

RDS(on)3 = $8.0 \text{ m}\Omega$ (TYP.) (VGS = 4.0 V, ID = 7.0 A)

- Low Ciss : Ciss = 3000 pF (TYP.)
- · Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

1,2,3 ; Source 4 ; Gate 5,6,7,8 ; Drain 6.0 ±0.3 4.4 0.8 1,2,3 ; Source 4 ; Gate 5,6,7,8 ; Drain

PACKAGE DRAWING (Unit: mm)

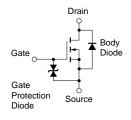
ORDERING INFORMATION

| PART NUMBER | PACKAGE |
|-------------|------------|
| μPA1706G | Power SOP8 |

EQUIVALENT CIRCUIT

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected)

| Drain to Source Voltage Note1 | Voss | 30 | V |
|---|----------|--------------|----|
| Gate to Source Voltage Note2 | Vgss | ±20 | V |
| Drain Current (DC) | ID(DC) | ±13 | Α |
| Drain Current (pulse) Note3 | D(pulse) | ±52 | Α |
| Total Power Dissipation $(T_A = 25^{\circ}C)^{Note4}$ | Рт | 2.0 | W |
| Channel Temperature | Tch | 150 | °C |
| Storage Temperature | Tstg | -55 to + 150 | °C |



- Notes 1. Vgs = 0 V
 - **2.** $V_{DS} = 0 V$
 - **3.** PW \leq 10 μ s, Duty Cycle \leq 1 %
 - **4.** Mounted on ceramic substrate of 1200 mm² x 0.7mm

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

The information in this document is subject to change without notice.

Document No.
Date Published
Printed in Japan

G13083EJ1V0DS00 (1st edition) January 1999 NS CP(K)

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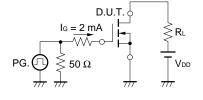


ELECTRICAL CHARACTERISTICS (T_A = 25°C, All terminals are connected)

| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------|----------------------|---|------|------|------|------|
| Drain to Source On-state Resistance | RDS(on)1 | Vgs = 10 V, ID = 7.0 A | | 5.8 | 7.8 | mΩ |
| | RDS(on)2 | Vgs = 4.5 V, ID = 7.0 A | | 7.0 | 10.0 | mΩ |
| | RDS(on)3 | V _{GS} = 4.0 V, I _D = 7.0 A | | 8.0 | 12.0 | mΩ |
| Gate to Source Cut-off Voltage | V _{GS(off)} | V _{DS} = 10 V, I _D = 1 mA | 1.5 | 2.0 | 2.5 | V |
| Forward Transfer Admittance | yfs | V _{DS} = 10 V, I _D = 7.0 A | 10 | 22 | | S |
| Drain Leakage Current | Ipss | VDS = 30 V, VGS = 0 V | | | 10 | μΑ |
| Gate to Source Leakage Current | Igss | VGS = ±20 V, VDS = 0 V | | | ±10 | μΑ |
| Input Capacitance | Ciss | V _{DS} = 10 V | | 3000 | | pF |
| Output Capacitance | Coss | VGS = 0 V | | 950 | | pF |
| Reverse Transfer Capacitance | Crss | f = 1 MHz | | 380 | | pF |
| Turn-on Delay Time | td(on) | ID = 7.0 A | | 40 | | ns |
| Rise Time | tr | V _{GS(on)} = 10 V | | 220 | | ns |
| Turn-off Delay Time | td(off) | V _{DD} = 15 V | | 140 | | ns |
| Fall Time | t _f | R _G = 10 Ω | | 90 | | ns |
| Total Gate Charge | Q _G | ID = 13 A | | 56 | | nC |
| Gate to Source Charge | Qgs | VDD = 24 V | | 9 | | nC |
| Gate to Drain Charge | Q _{GD} | V _{GS} = 10 V | | 14 | | nC |
| Body Diode Forward Voltage | V _F (S-D) | IF = 13 A, VGS = 0 V | | 0.8 | | V |
| Reverse Recovery Time | trr | IF = 13 A, Vgs = 0 V | | 43 | | ns |
| Reverse Recovery Charge | Qrr | $di/dt = 100 A/ \mu s$ | | 50 | | nC |

TEST CIRCUIT 1 SWITCHING TIME

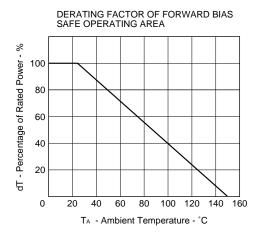
TEST CIRCUIT 2 GATE CHARGE

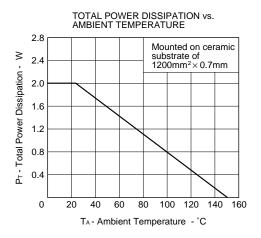


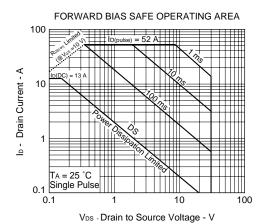
Vgs

 $\tau = 1 \mu \text{ s}$ Duty Cycle $\leq 1 \%$

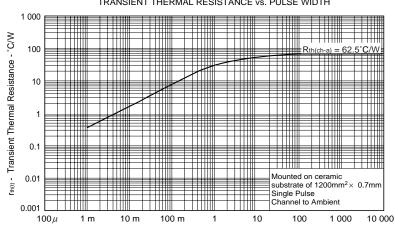
TYPICAL CHARACTERISTICS (TA = 25 °C)





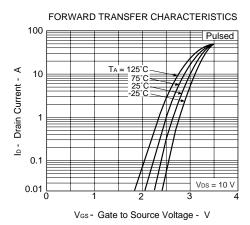


Remark Mounted on ceramic substrate of $1200 \text{mm}^2 \times 0.7 \text{mm}$

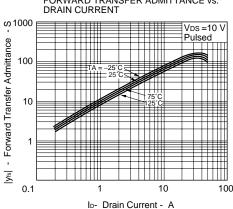


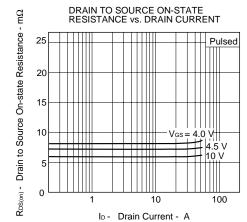
3

PW - Pulse Width - s

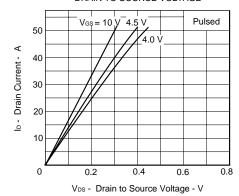




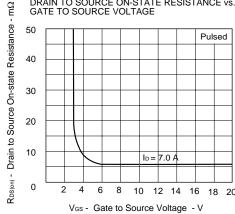




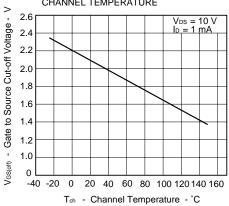
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

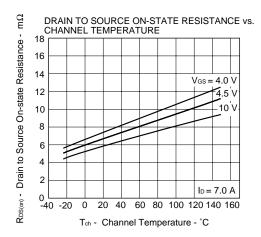


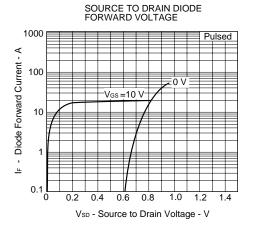
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

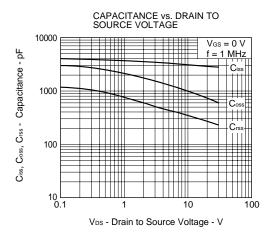


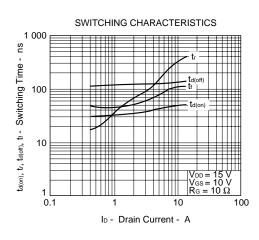
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE

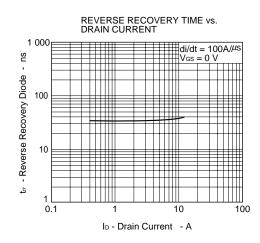


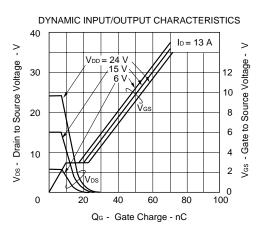












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NEC μ PA1706

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Anti-radioactive design is not implemented in this product.

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